

Tack Flux No-Clean in Jar 75g

Product Highlights

- Ideal for all rework, solder, de-solder and reflow applications
- Non-corrosive, non-conductive, no-clean
- Tack flux will not run all over PCB when applied
- Has a pleasant odor
- Excellent wetting
- Easily cleaned with isopropyl alcohol (IPA)
- Attachment of BGA spheres
- Soldering flip chip components
- Long stencil life
- Wide process window
- Clear residue
- Can be used with Leaded and Lead-Free applications

RoHS 3 and REACH compliant



Specifications

Flux Type:	Synthetic No-Clean (for Leaded and Lead-Free applications)
Flux Classification:	RELO
Flux Activation Temperature:	140°C (284°F)
Color:	Light yellow to orange/brown
Packaging:	Jar 75g
Shelf Life:	Refrigerated >24 months, Unrefrigerated >24 months

Stencil Life

- >8 hours @ 20-50% RH 22-28°C (72-82°F)
- >4 hours @ 50-70% RH 22-28°C (72-82°F)

Stencil Cleaning

Automated stencil cleaning systems for both stencil and misprinted boards. Manual cleaning using isopropyl alcohol (IPA).

Storage and Handling

Store refrigerated or at room temperature 3-25°C (37-77°F). Do not freeze. Allow 4 hours for flux to reach an operating temperature of 20-25°C (68-77°F) before use.

Transportation

This product has no shipping restrictions. Shipping below 0°C (32°F) or above 25°C (77°F) for normal transit times by ground or air will not impact this product's stated shelf life.

Conforms to the following Industry Standards:

J-STD-004B, Amendment 1 (Solder Fluxes):	Yes
RoHS 3 Directive (EU) 2015/863:	Yes